

APPLICABLE STANDARD					
RATING	OPERATING TEMPERATURE RANGE	-35°C TO +85°C(NOTE 1)	STORAGE TEMPERATURE RANGE	-10°C TO +60°C(NOTE 3)	
	OPERATING HUMIDITY RANGE	40 % TO 80 % (NOTE 2)	STORAGE HUMIDITY RANGE	40 % TO 70 %(NOTE 3)	
	CURRENT	1 A/pin	VOLTAGE	150 V AC/DC	
	APPLICABLE CONNECTOR	DF14-*S-1.25C	APPLICABLE CONTACT	DF14-****SCFA(##)	
SPECIFICATIONS					
ITEM		TEST METHOD		REQUIREMENTS	QT AT
CONSTRUCTION					
GENERAL EXAMINATION		VISUALLY AND BY MEASURING INSTRUMENT.		ACCORDING TO DRAWING.	X X
MARKING		CONFIRMED VISUALLY.			X X
ELECTRIC CHARACTERISTICS					
CONTACT RESISTANCE		20 mV MAX, 1mA (DC OR 1000 Hz)		30 mΩ MAX.	X —
INSULATION RESISTANCE		100 V DC.		500 MΩ MIN.	X —
VOLTAGE PROOF		500 V AC FOR 1 min.		NO FLASHOVER OR BREAKDOWN.	X —
MECHANICAL CHARACTERISTICS					
MECHANICAL OPERATION		50 TIMES INSERTIONS AND EXTRACTIONS.		1) CONTACT RESISTANCE: 30 mΩ MAX. 2) NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X —
VIBRATION		FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE 0.75 mm, AT 2 h, FOR 3 DIRECTIONS.		1) NO ELECTRICAL DISCONTINUITY OF 1μs. 2) NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X —
SHOCK		490 m/s <sup>2</sup> DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.			
ENVIRONMENTAL CHARACTERISTICS					
RAPID CHANGE OF TEMPERATURE		TEMPERATURE -55→ 5 TO 35→ +85→ 5 TO 35 °C TIME 30→ 10 TO 15→30→ 10 TO 15 min. UNDER 5 CYCLES.		1) CONTACT RESISTANCE: 30mΩ MAX. 2) INSULATION RESISTANCE: 500 MΩ MIN. 3) NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X —
DAMP HEAT (STEADY STATE)		EXPOSED AT 40±2 °C, 90 ~ 95 %, 96 h.			
RESISTANCE TO SOLDERING HEAT		1) REFLOW SOLDERING « REFLOW AREA » MAX 250°C WITHIN 10 sec MIN 230°C WITHIN 60 sec « PREHEATING AREA » 170°C TO 190°C 60 sec TO 120 sec PUT THROUGH IN REFLOW FUMACE TWICE. LEAVE IN AMBIENT TEMPERATURE AND HUMIDITY FOR 1 HOUR. CONNECTOR TEMPERTURE TO BE AMBIENT FOR SECOND REFLOW. 2) MANUAL SOLDERING SOLDERING IRON TEMPERATURE 350±5 °C, FOR5±1 sec. NO STRENGTH ON CONTACT.		NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.	X —
SOLDERABILITY		SOLDERING TEMPERATURE : 245±5°C DURATION OF IMMERSION : SOLDERING, FOR 3sec.		A NEW UNIFORM COATING OF SOLDER SHALL COVER MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.	X —
REMARKS					
NOTE1: INCLUDING THE TEMPERATURE RISE BY CURRENT.					
NOTE2: NO CONDENSING.					
NOTE3: APPLY TO THE CONDITION OF LONG TERM STORAGE FOR UNUSED PRODUCTS BEFORE MOUNTED ON PCB.					
AFTER MOUNTED ON PCB, OPERATING TEMPERATURE AND HUMIDITY RANGE IS APPLIED FOR INTERIM STORAGE DURING TRANSPORTATION.					
	COUNT	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE
⚠	1	DIS-H-00006251	HK.HAYASHI	SZ.ONO	20200817
Unless otherwise specified, refer to IEC 60512.				APPROVED	KJ.KATAYOSE 20050105
⚠ Format change.				CHECKED	TY.OMA 20050105
				DESIGNED	TS.KUMAZAWA 20050105
				DRAWN	TS.KUMAZAWA 20050105
Note QT: Qualification Test AT: Assurance Test X:Applicable Test			DRAWING NO.		ELC-160309-56-17
<b>HRS</b>	SPECIFICATION SHEET		PART NO.	DF14A-*P-1.25H(56)	
	HIROSE ELECTRIC CO., LTD.		CODE NO.	CL538	⚠ 1/1